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## \*BIBDATASHEET\*

CONFIRMATION NO. 8725

Bib Data Sheet

SERIAL NUMBER 10/607,633	FILING DATE 06/27/2003  RULE	CLASS 257	GROUP ART UNIT 2823	ATTORNEY DOCKET NO. 018865-004210US
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a DIV of 09/464,885 12/16/1999 PAT 6,720,642 *QNB*

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

*NONE QND*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 09/22/2003

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY CA	SHEETS DRAWING 11	TOTAL CLAIMS 19	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged Examiner's Signature <i>William M. Brumby</i> Initials				

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## TITLE

Flip chip in leaded molded package and method of manufacture thereof

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
		<input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )